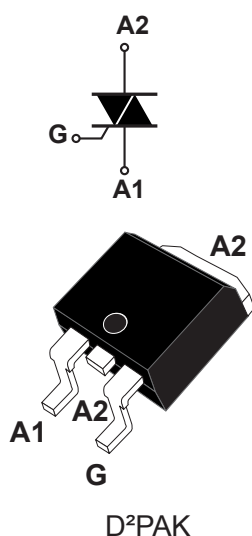


12 A - 800 V - 150 °C 8H Triac in D²PAK



Features

- 12 A medium current Triac
- 800 V symmetrical blocking voltage
- 150 °C maximum junction temperature T_j
- Three triggering quadrants
- High noise immunity - static dV/dt
- Robust dynamic turn-off commutation - $(dI/dt)_c$
- ECOPACK2 compliant component
- Molding resin UL94-V0 flammability certified

Applications

- General purpose AC line load control
- AC induction and universal motor control
- Lighting and automation I/O control
- Water heater, room heater and coffee machine
- Home automation smart AC plug
- Inrush current limiter in AC DC rectifiers

Description

Specifically designed to operate at 800 V and 150 °C, the T1235H-8G Triac housed in D²PAK provides an enhanced thermal management: this 12 A Triac is the right choice for a compact drive of AC loads and enables the heatsink size reduction.

D²PAK package is ideal for compact SMD designs on surface mount boards or insulated metal substrate boards.

Based on the ST high temperature Snubberless technology, it offers higher specified turn off commutation and noise immunity levels up to the T_j max.

The T1235H-8G safely optimizes the control of the hardest universal motors, heaters and inductive loads for industrial control and home appliances.

Snubberless is a trademark of STMicroelectronics.

Product status link	
T1235H-8G	
Product summary	
$I_{T(RMS)}$	12 A
V_{DRM}/V_{RRM}	800 V
V_{DSM}/V_{RSM}	900 V
I_{GT}	35 mA
T_j max.	150 °C

1 Characteristics

Table 1. Absolute maximum ratings (limiting values)

Symbol	Parameter		Value	Unit
$I_{T(RMS)}$	RMS on-state current (full sine wave)	$T_c = 135\text{ °C}$	12	A
I_{TSM}	Non repetitive surge peak on-state current (full cycle, T_j initial = 25 °C)	$t = 16.7\text{ ms}$	126	A
		$t = 20\text{ ms}$	120	
I^2t	I^2t value for fusing	$t_p = 10\text{ ms}$	95	A^2s
di/dt	Critical rate of rise of on-state current, $I_G = 2 \times I_{GT}$, $tr \leq 100\text{ ns}$, $f = 100\text{ Hz}$	$T_j = 25\text{ °C}$	100	$A/\mu s$
V_{DRM}/V_{RRM}	Repetitive peak off-state voltage		800	V
V_{DSM}/V_{RSM}	Non Repetitive peak off-state voltage	$t_p = 10\text{ ms}$, $T_j = 25\text{ °C}$	900	V
I_{GM}	Peak gate current	$t_p = 20\text{ }\mu s$, $T_j = 150\text{ °C}$	4	A
P_{GM}	Maximum gate power dissipation		5	W
$P_{G(AV)}$	Average gate power dissipation	$T_j = 150\text{ °C}$	1	W
T_{stg}	Storage temperature range		-40 to +150	$^{\circ}C$
T_j	Operating junction temperature range		-40 to +150	$^{\circ}C$

Table 2. Electrical characteristics ($T_j = 25\text{ °C}$, unless otherwise specified)

Symbol	Test conditions		Quadrants		Value	Unit
I_{GT}	$V_D = 12\text{ V}$, $R_L = 30\text{ }\Omega$		I - II - III	Min.	5	mA
				Max.	35	mA
V_{GT}	$V_D = 12\text{ V}$, $R_L = 30\text{ }\Omega$		I - II - III	Max.	1.3	V
V_{GD}	$V_D = V_{DRM}$, $R_L = 3.3\text{ k}\Omega$	$T_j = 150\text{ °C}$	I - II - III	Min.	0.15	V
I_L	$I_G = 1.2 \times I_{GT}$		I - III	Max.	50	mA
			II	Max.	80	mA
$I_H^{(1)}$	$I_T = 500\text{ mA}$, gate open			Max.	35	mA
$dV/dt^{(1)}$	$V_D = V_R = 536\text{ V}$, gate open		$T_j = 150\text{ °C}$	Min.	2000	$V/\mu s$
$(di/dt)_c^{(1)}$	Without snubber network		$T_j = 150\text{ °C}$	Min.	12	A/ms

1. For both polarities of A2 referenced to A1.

Table 3. Static characteristics

Symbol	Test conditions	T_j		Value	Unit
$V_{TM}^{(1)}$	$I_{TM} = 17\text{ A}$, $t_p = 380\text{ }\mu\text{s}$	25 °C	Max.	1.50	V
$V_{TO}^{(1)}$	Threshold voltage	150 °C	Max.	0.80	V
$R_D^{(1)}$	Dynamic resistance	150 °C	Max.	32	mΩ
I_{DRM}/I_{RRM}	$V_D = V_R = V_{DRM} = V_{RRM}$	25 °C	Max.	2.0	μA
		150 °C		4.5	mA
	$V_D = V_R = 400\text{ V}$, peak voltage	150 °C	Max.	1.7	mA

1. For both polarities of A2 referenced to A1.

Table 4. Thermal resistance

Symbol	Parameter		Value	Unit
$R_{th(j-c)}$	Junction to case (AC)	Max.	1.1	°C/W
$R_{th(j-a)}$	Junction to ambient ($S_{CU}^{(1)} = 2\text{ cm}^2$)	Typ.	45	°C/W

1. S_{cu} : copper pad surface under tab, 35 μm copper thickness on FR4 PCB.

1.1 Characteristics (curves)

Figure 1. Maximum power dissipation versus on-state RMS current (full cycle)

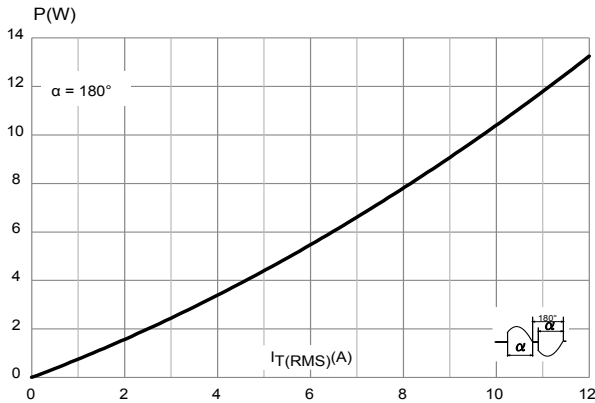


Figure 2. On-state RMS current versus case temperature (full cycle)

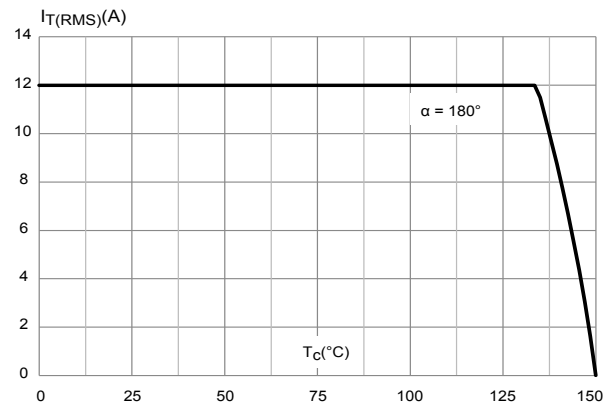


Figure 3. On-state RMS current versus ambient temperature (free air convection)

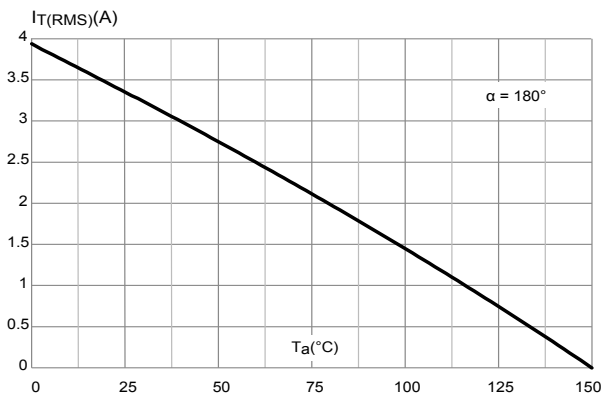


Figure 4. On-state characteristics (maximum values)

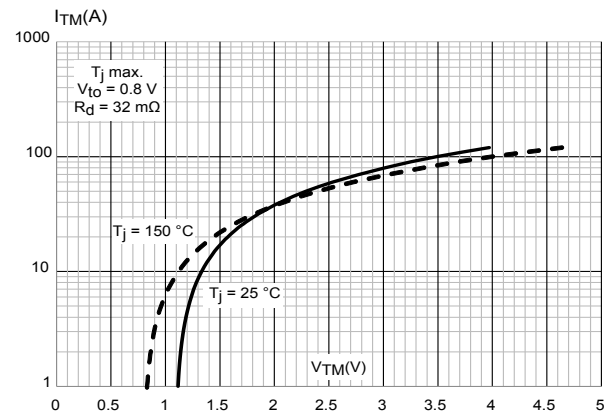


Figure 5. Relative variation of thermal impedance versus pulse duration

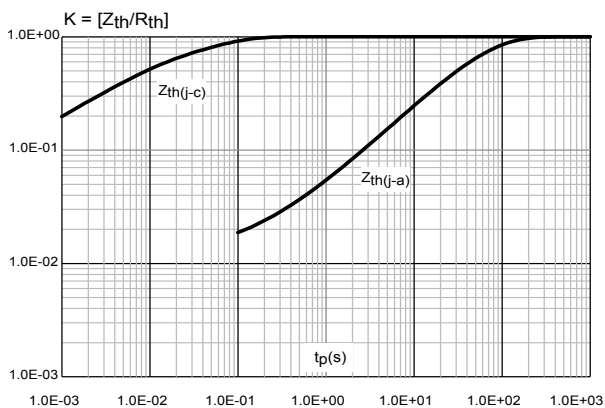


Figure 6. Recommended maximum case-to-ambient thermal resistance versus ambient temperature for different peak off-state voltages

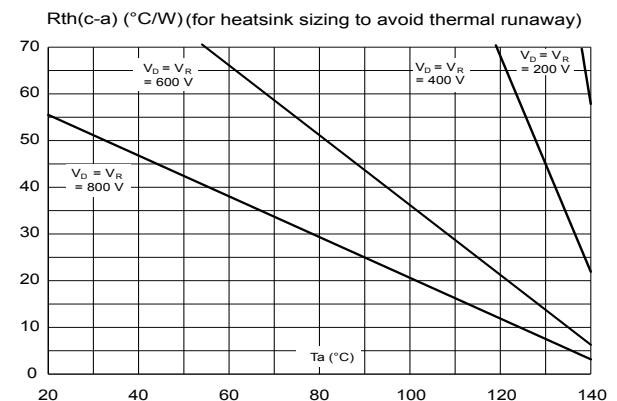


Figure 7. Thermal resistance junction to ambient versus copper surface under tab

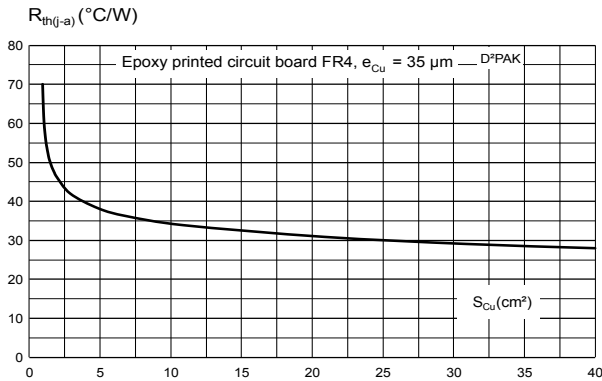


Figure 8. Relative variation of leakage current versus junction temperature for different values of blocking voltage

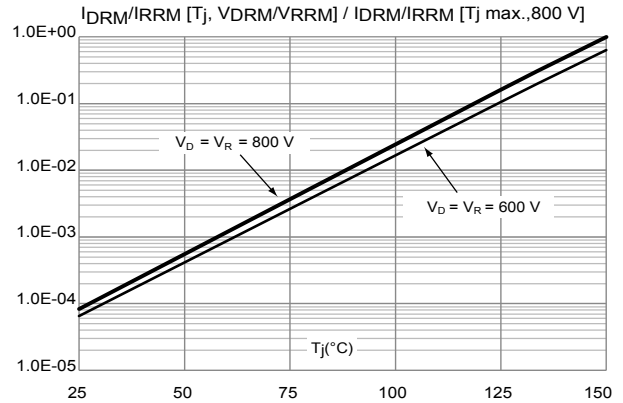


Figure 9. Relative variation of gate trigger voltage and current versus junction temperature (typical values)

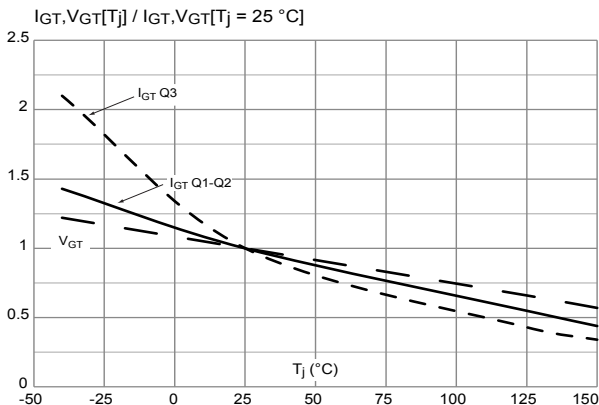


Figure 10. Relative variation of holding current and latching current versus junction temperature (typical values)

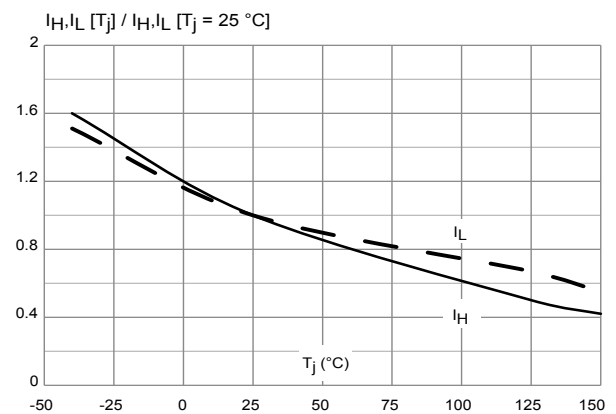


Figure 11. Surge peak on-state current versus number of cycles

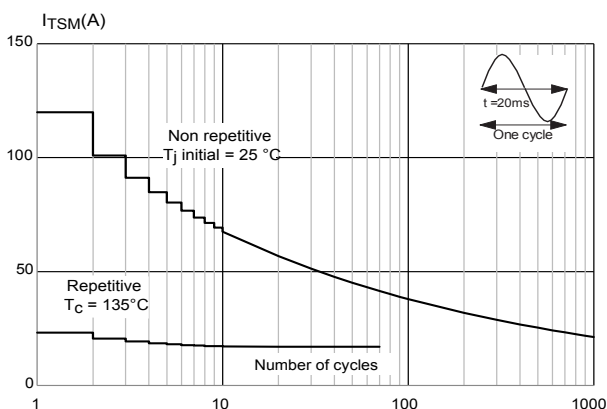


Figure 12. Non repetitive surge peak on-state current for a sinusoidal pulse with width $t_p < 10$ ms

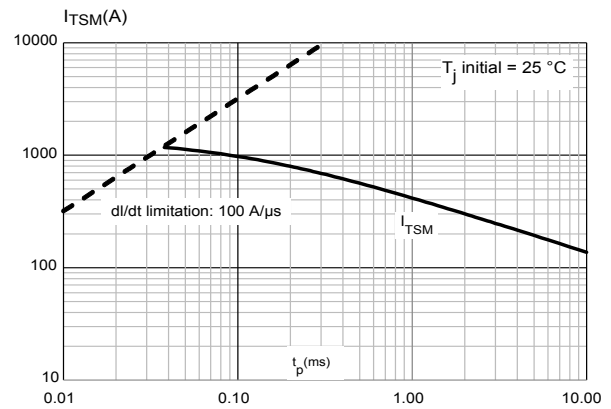


Figure 13. Relative variation of static dV/dt immunity versus junction temperature

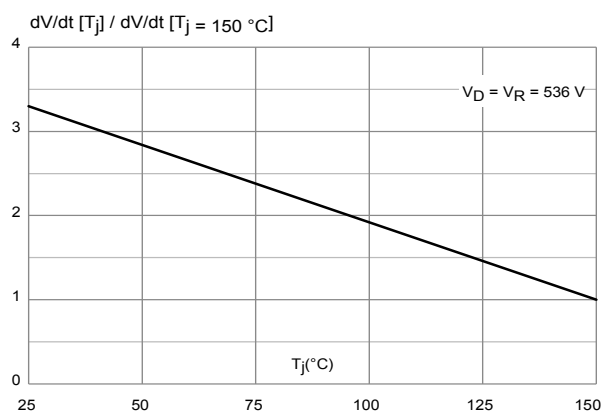
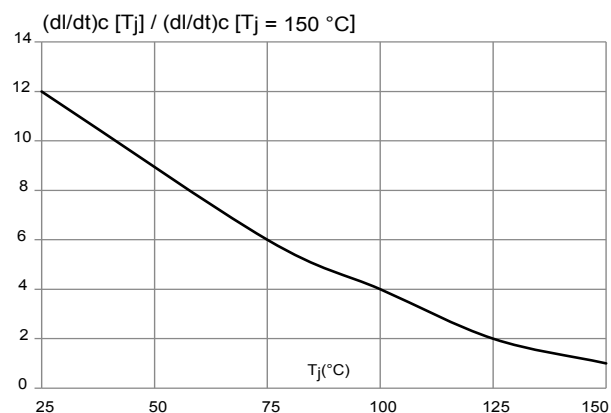


Figure 14. Relative variation of critical rate of decrease of main current versus junction temperature



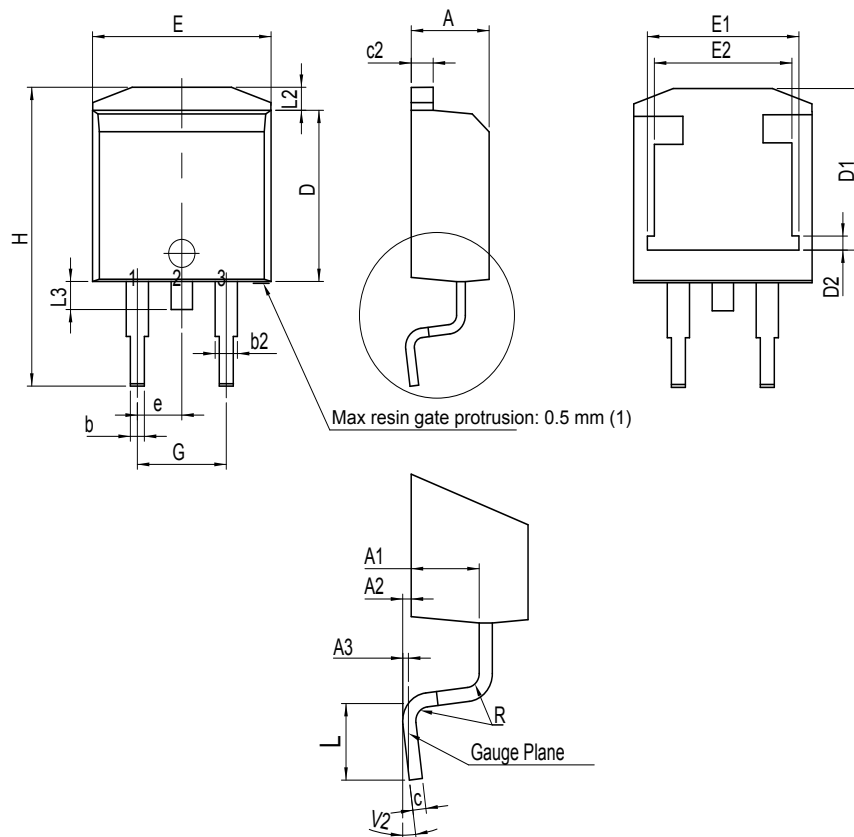
2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of **ECOPACK** packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

2.1 D²PAK package information

- **ECOPACK2** compliant
- Lead-free package leads finishing
- Molding compound resin is halogen-free and meets UL94 flammability standard level V0

Figure 15. D²PAK package outline



(1) Resin gate is accepted in each of position shown on the drawing, or their symmetrical.

Table 5. D²PAK package mechanical data

Ref.	Dimensions					
	Millimeters			Inches ⁽¹⁾		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.30		4.60	0.1693		0.1811
A1	2.49		2.69	0.0980		0.1059
A2	0.03		0.23	0.0012		0.0091
A3		0.25			0.0098	
b	0.70		0.93	0.0276		0.0366
b2	1.25		1.7	0.0492		0.0669
c	0.45		0.60	0.0177		0.0236
c2	1.21		1.36	0.0476		0.0535
D	8.95		9.35	0.3524		0.3681
D1	7.50		8.00	0.2953		0.3150
D2	1.30		1.70	0.0512		0.0669
e	2.54			0.10000		
E	10.00		10.28	0.3937		0.4047
E1	8.30		8.70	0.3268		0.3425
E2	6.85		7.25	0.2697		0.2854
G	4.88		5.28	0.1921		0.2079
H	15		15.85	0.5906		0.6240
L	1.78		2.28	0.0701		0.0898
L2	1.19		1.40	0.0468		0.0551
L3	1.40		1.75	0.0551		0.0689
R		0.40			0.0157	
V2 ⁽²⁾	0°		8°	0°		8°

1. Dimensions in inches are given for reference only

2. Degrees

Technical drawing of a stepped profile. The profile consists of a large rectangular block on the left and two smaller rectangular blocks on the right. The dimensions are as follows:

- The total width of the profile is 16.90.
- The width of the large rectangular block is 8.90.
- The height of the large rectangular block is 10.30.
- The width of the first small rectangular block on the right is 3.70.
- The height of the first small rectangular block is 1.30.
- The height of the second small rectangular block is 5.08.

Technical drawing of a rectangular plate with a grid of 12 squares (3 rows by 4 columns). The plate has a total width of 8,90 and a total height of 10,30. The grid is composed of 12 squares, each with a side length of 2,27. The plate has a thickness of 0,05. The drawing shows the plate from the front and side views. The front view shows the grid and the dimensions. The side view shows the thickness and the height of the plate. The drawing is in a technical style with dimension lines and numerical values.

3 Ordering information

Figure 18. Ordering information scheme

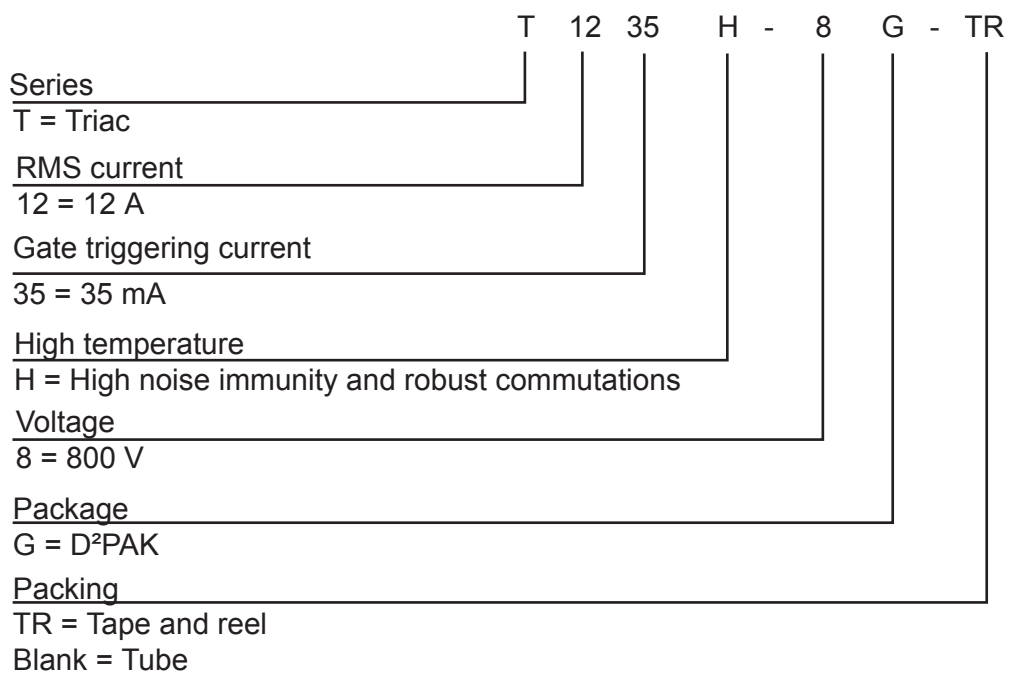


Table 6. Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
T1235H-8G-TR	T1235H-8G	D ² PAK	1.6 g	1000	Tape and reel 13"
T1235H-8G				50	Tube

Revision history

Table 7. Document revision history

Date	Version	Changes
20-Nov-2020	1	Initial release.
16-Dec-2020	2	Updated general description. Inserted STPOWER logo.

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